

客户 (Customer) : \_\_\_\_\_

承认书

Approval Sheet

谨致执事者：兹提供敝公司之有关详细规格及图面数据，敬请给予办理试认定手续。  
同时敬请送返一份附有贵公司签认之测试认定后之样品承认书。

We are pleased in sending you herewith on specification and drawings for your approval.  
Please return to us one copy "Approval sheet" with your approved signature.

型号 (Model No.) : A-SC633W1D-H65-4T

发文日期 (Issue Date) : 2022/03/18 承认日期 (Approved Date) : \_\_\_\_\_

Checking signature of Amicc

| Designer | Checker | Approver |
|----------|---------|----------|
| Zora     | Tommy   | Solarliu |

Approval signature of customer

| Designer | Checker | Approver |
|----------|---------|----------|
|          |         |          |

江苏欧密格光电科技股份有限公司

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## Top view LED Type ■ PLCC Package

### A-SC633W1D-H65-4T



#### ■ Description

The Amicc 633 package has high efficacy, low power consumption, wide viewing angle and a compact form factor. These features make this package to be an ideal LED for all lighting applications.

#### ■ Features

- Top view LED
- High luminous Intensity output
- Wide viewing angle
- Pb-free
- RoHS compliant
- JEDEC MSL 3

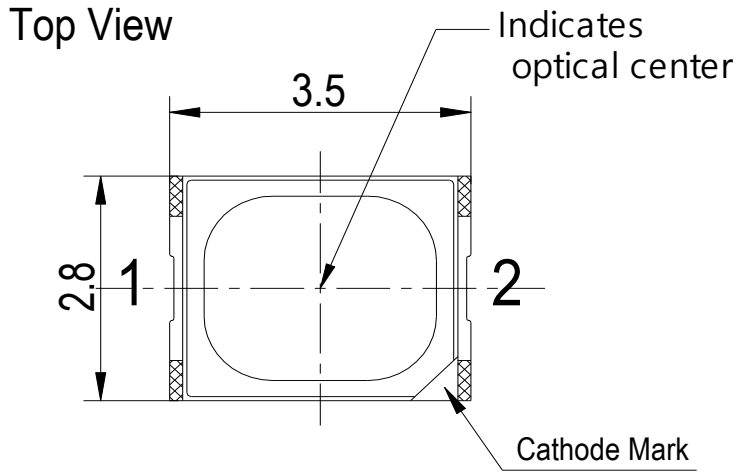
#### ■ Applications

- General lighting
- Decorative and Entertainment Lighting
- Indicators
- Illumination
- Switch lights

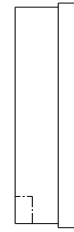
#### ■ Device Selection Guide

| Chip Materials | Emitted Color | Resin Color |
|----------------|---------------|-------------|
| InGaN          | White         | Yellow      |

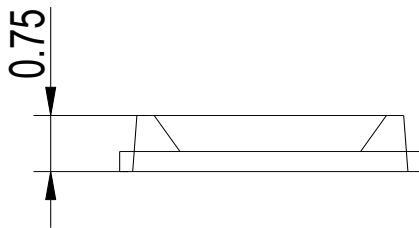
■ Package Dimensions



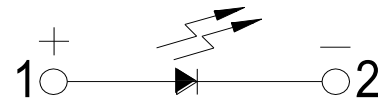
Side View



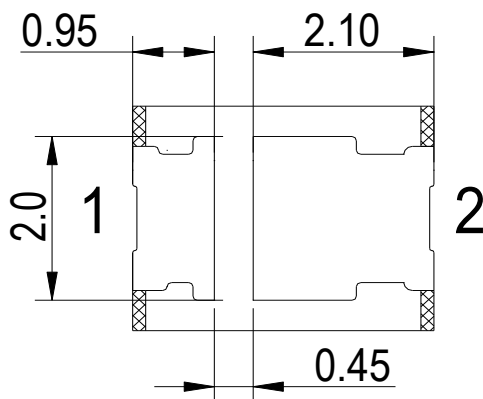
Side View



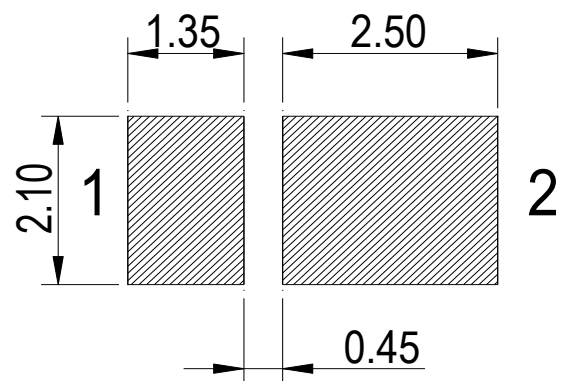
Polarity



Bottom View



Recommended solder pad



Notes:

1. Dimensions are in millimeters
2. Tolerance unless mentioned is  $\pm 0.1\text{mm}$ .

■ **Absolute Maximum Ratings** ( $T_{\text{Soldering}}=25^{\circ}\text{C}$ )

| Parameter                             | Symbol    | Rating                                                                                                      | Unit               |
|---------------------------------------|-----------|-------------------------------------------------------------------------------------------------------------|--------------------|
| Forward Current                       | $I_F$     | 150                                                                                                         | mA                 |
| Peak Forward Current (Duty 1/10 @1ms) | $I_{FP}$  | 200                                                                                                         | mA                 |
| Power Dissipation                     | $P_d$     | 500                                                                                                         | mW                 |
| Operating Temperature                 | $T_{opr}$ | -40 ~ +85                                                                                                   | $^{\circ}\text{C}$ |
| Storage Temperature                   | $T_{stg}$ | -40 ~ +100                                                                                                  | $^{\circ}\text{C}$ |
| Soldering Temperature                 | $T_{sol}$ | Reflow Soldering : 260 $^{\circ}\text{C}$ for 10 sec.<br>Hand Soldering : 350 $^{\circ}\text{C}$ for 3 sec. |                    |

Note:

The products are sensitive to static electricity and must be carefully taken when handling products.

■ **Electro-Optical Characteristics** ( $T_{\text{Soldering}}=25^{\circ}\text{C}$ )

| Parameter             | Symbol          | Min.  | Typ.  | Max.  | Unit          | Condition         |
|-----------------------|-----------------|-------|-------|-------|---------------|-------------------|
| Luminous Flux         | $I_v$           | 17    | ----- | 33    | lm            | $I_F=60\text{mA}$ |
| Color Temperature     | CCT             | ----- | 6500  | ----- | K             | $I_F=60\text{mA}$ |
| Forward Voltage       | $V_F$           | 2.6   | ----- | 3.2   | V             | $I_F=60\text{mA}$ |
| Color Rendering Index | CRI             | ----- | 80    | ----- | -----         | $I_F=60\text{mA}$ |
| Viewing Angle         | $2\theta_{1/2}$ | ----- | 120   | ----- | deg           | $I_F=60\text{mA}$ |
| Reverse Current       | $I_R$           | ----- | ----- | 10    | $\mu\text{A}$ | $V_R=5\text{V}$   |

Notes:

1. Tolerance of Luminous Flux:  $\pm 10\%$ .
2. Tolerance of Forward Voltage:  $\pm 0.1\text{V}$ .

### ■ Bin Range of Luminous Flux

| Bin Code | Min. | Max. | Unit | Condition            |
|----------|------|------|------|----------------------|
| L13      | 20   | 23   | lm   | I <sub>F</sub> =60mA |
| L14      | 23   | 27   |      |                      |
| L15      | 27   | 33   |      |                      |

Note:  
Tolerance of Luminous Flux: ±10%.

### ■ Bin Range of Forward Voltage

| Bin Code | Min. | Max. | Unit | Condition            |
|----------|------|------|------|----------------------|
| 33       | 2.6  | 2.8  | V    | I <sub>F</sub> =60mA |
| 36       | 2.8  | 3.0  |      |                      |
| 38       | 3.0  | 3.2  |      |                      |

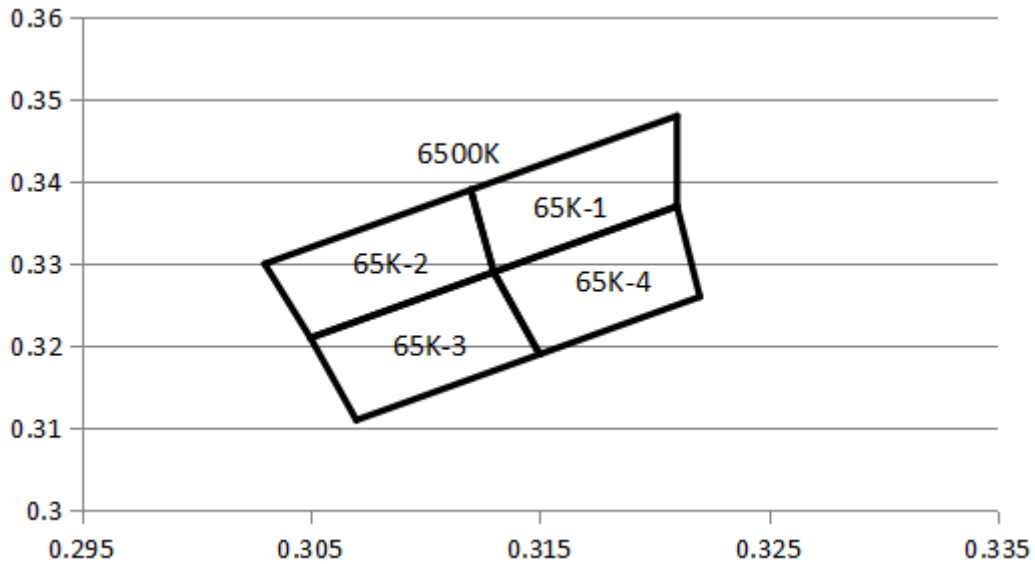
Note:  
Tolerance of Forward Voltage: ±0.1V.

### ■ Bin Range of Chromaticity Coordinates

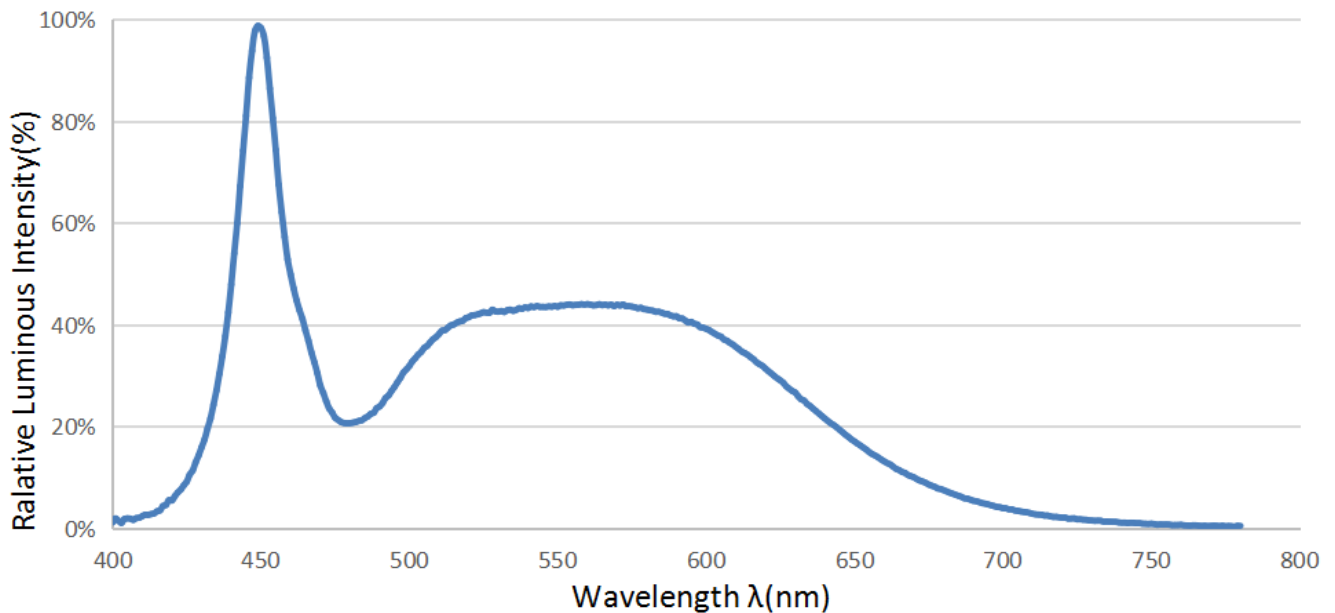
| Bin Code | CIE_x | CIE_y | Bin Code | CIE_x | CIE_y |
|----------|-------|-------|----------|-------|-------|
| 65K-1    | 0.312 | 0.339 | 65K-2    | 0.303 | 0.33  |
|          | 0.313 | 0.329 |          | 0.305 | 0.321 |
|          | 0.321 | 0.337 |          | 0.313 | 0.329 |
|          | 0.321 | 0.348 |          | 0.312 | 0.339 |
| 65K-3    | 0.305 | 0.321 | 65K-4    | 0.313 | 0.329 |
|          | 0.307 | 0.311 |          | 0.315 | 0.319 |
|          | 0.315 | 0.319 |          | 0.322 | 0.326 |
|          | 0.313 | 0.329 |          | 0.321 | 0.337 |

Notes:  
1. The value is based on driving current by 60mA.  
2. Tolerance of Chromaticity Coordinates: ±0.01.  
3. Chromaticity specification defined by ANSI.

## ■ The C.I.E. 1931 Chromaticity Diagram



## ■ Spectrum Distribution



## ■ Typical Electro-Optical Characteristics Curves

Fig.1-Forward Voltage Shift vs. Junction Temperature

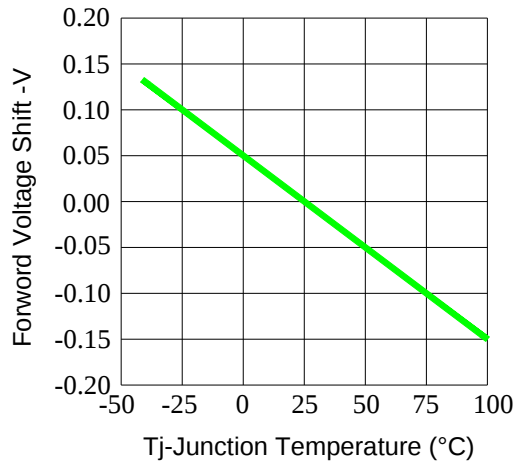


Fig.2- Luminous Flux vs. Forward Current

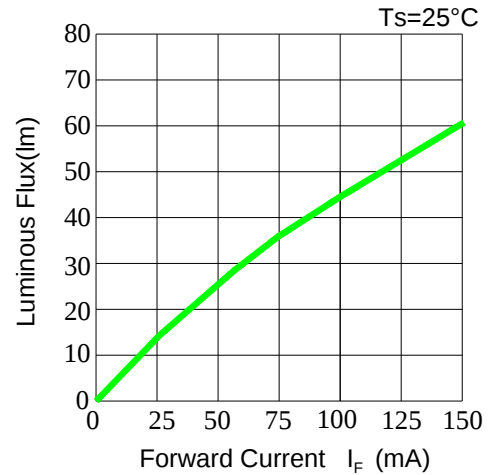


Fig.3-Relative Luminous Intensity vs. Junction Temperature

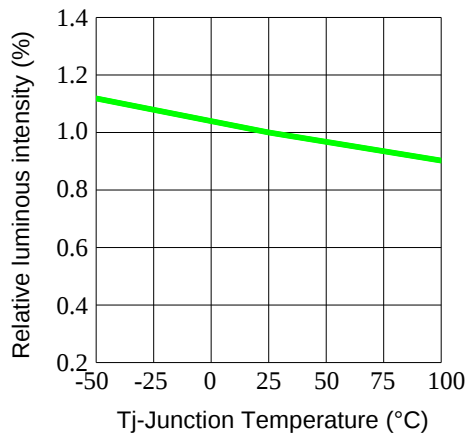


Fig.4-Forward Current vs. Forward Voltage T<sub>a</sub>=25°C

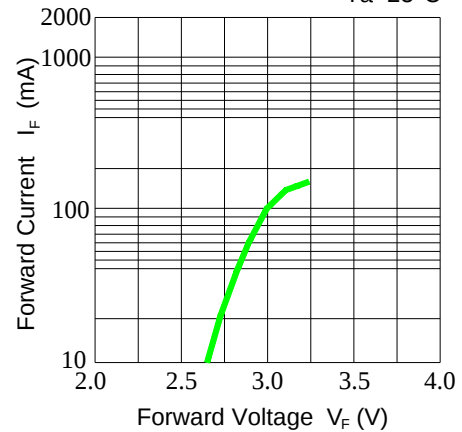


Fig.5-Max.Driving Forward Current vs. Soldering Temperature

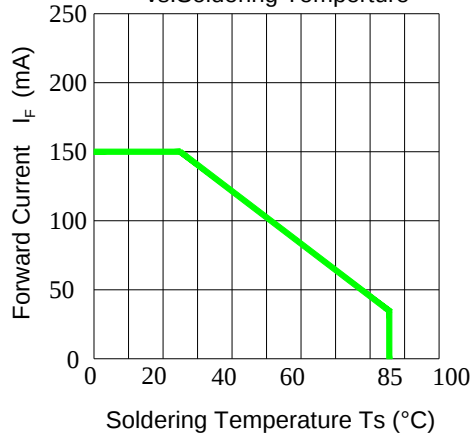
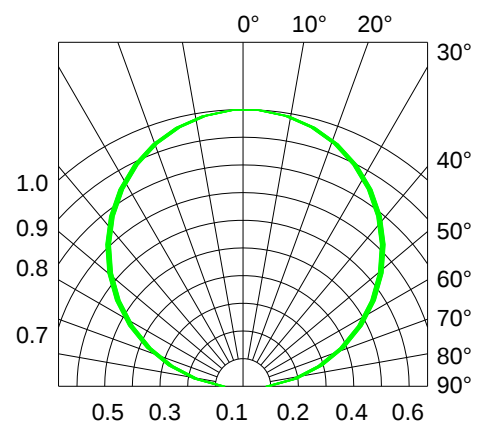


Fig.6-Radiation Diagram T<sub>a</sub>=25°C



## ■ Moisture Resistant Packing Materials

### 1. Label Explanation



AMICC OPTO-ELECTRONICS  
TECHNOLOGY Co.,LTD



P/N: × × × × × × × ×

TYPE: × - × × × × × × × ×

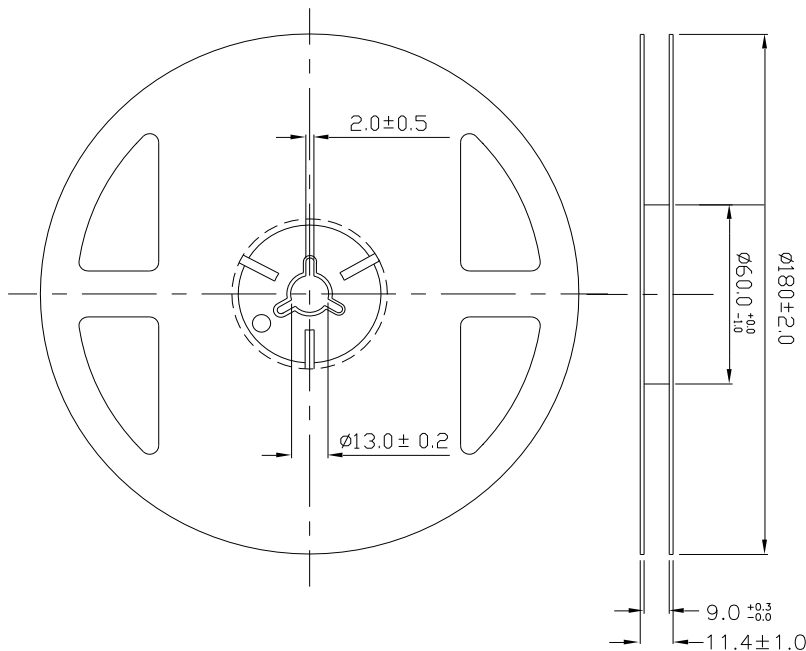
|         | CODE            | MIN | MAX | UNIT         |
|---------|-----------------|-----|-----|--------------|
| IV:     | × ×             | × × | × × | lm           |
| HUE:    | × ×             | × × | × × |              |
| VF:     | × ×             | × × | × × | V            |
| LOT NO: | × × × × × × × × |     |     | QTY: × × × × |



MADE IN CHINA

- CPN: Customer's Product Number
- P/N: Product Number
- TYPE: Part NO.
- IV: Luminous Flux Rank
- HUE: Chromaticity Coordinates Rank
- VF: Forward Voltage Rank
- LOT No: Lot Number
- QTY: Packing Quantity

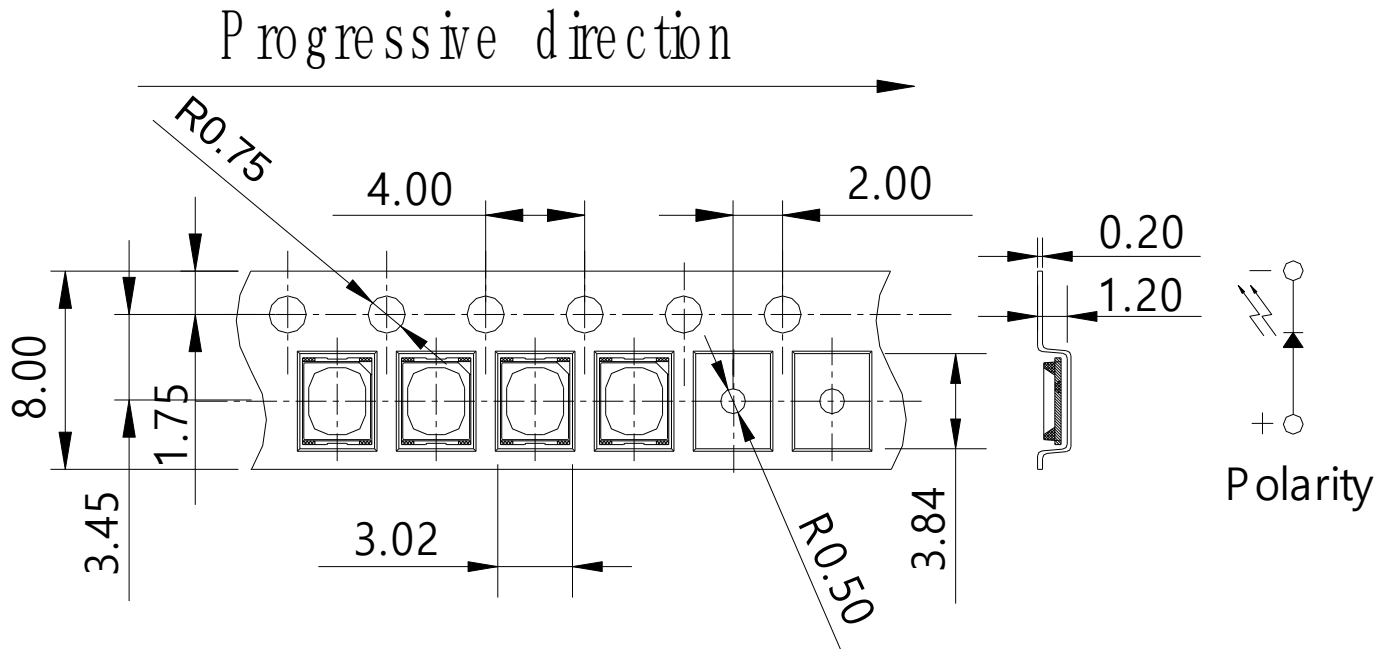
### 2. Reel Dimensions



#### Note:

1. Dimensions are in millimeters
2. Tolerance unless mentioned is  $\pm 0.1$ mm.

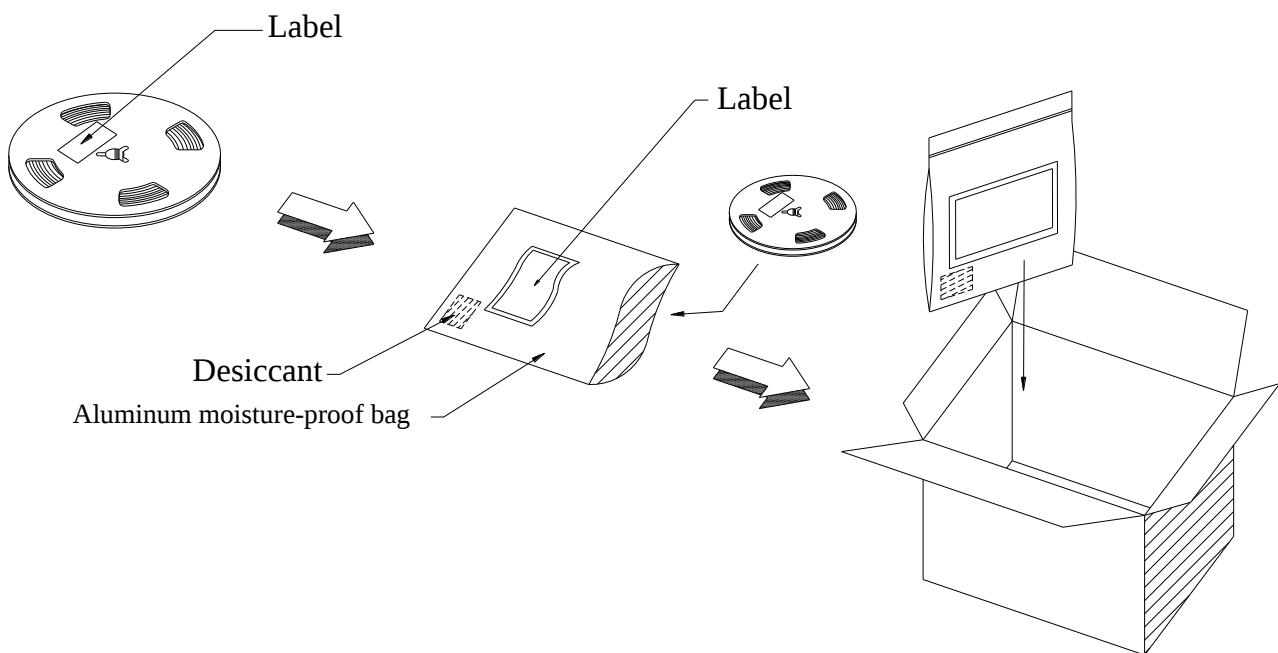
### 3. Carrier Tape Dimensions: Loaded Quantity 4000 pcs Per Reel



#### Notes:

1. Dimensions are in millimeters
2. Tolerance unless mentioned is  $\pm 0.1\text{mm}$ .
3. Minimum packing amount is 1000 pcs per reel.

### 4. Moisture Resistant Packing Process



## ■ Reliability Test Items and Conditions

The reliability of products shall be satisfied with items listed below.

Confidence level : 90%

LTPD : 10%

| No. | Items                                     | Test Condition                                 | Test Hours/Cycles | Sample Size | Ac/Re |
|-----|-------------------------------------------|------------------------------------------------|-------------------|-------------|-------|
| 1   | Reflow Soldering                          | Temp. : 260°C/10sec.                           | 6 Min.            | 22 PCS.     | 0/1   |
| 2   | Thermal Shock                             | H : +100°C 5min<br>∫ 10 sec<br>L : -10°C 5min  | 100 Cycles        | 22 PCS.     | 0/1   |
| 3   | Temperature Cycle                         | H : +100°C 15min<br>∫ 5 min<br>L : -40°C 15min | 100 Cycles        | 22 PCS.     | 0/1   |
| 4   | High Temperature/Humidity<br>Reverse Bias | Ta=85°C,85%RH                                  | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 5   | Low Temperature Storage                   | Ta=-40°C                                       | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 6   | High Temperature Storage                  | Ta=100°C                                       | 1000 Hrs.         | 22 PCS.     | 0/1   |
| 7   | DC Operation Life                         | Ta=25°C<br>I <sub>F</sub> = 150 mA             | 1000 Hrs.         | 22 PCS.     | 0/1   |

## ■ Precautions for Use

### 1. Over-current-proof

Customer must apply resistors for protection; otherwise slight voltage shift will cause big current change (Burn out will happen).

### 2. Storage

2.1 Do not open moisture proof bag before the products are ready to use.

2.2 Before opening the package: The LEDs should be kept at 30°C or less and 90%RH or less.

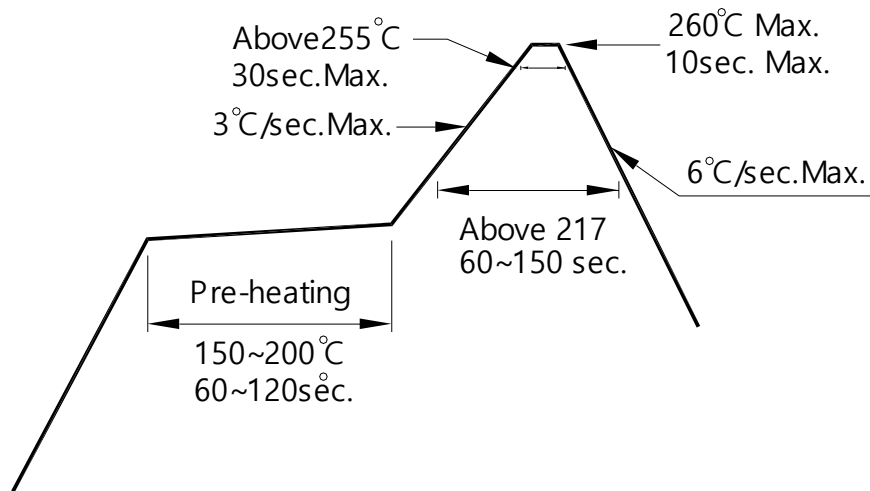
2.3 After opening the package: The LED's floor life is 168 Hrs under 30°C or less and 60% RH or less. If unused LEDs remain, it should be stored in moisture proof packages.

2.4 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment: 60±5°C for 24 hours.

### 3. Soldering Condition

#### 3.1 Pb-free solder temperature profile



3.2 Reflow soldering should not be done more than two times.

3.3 When soldering, do not put stress on the LEDs during heating.

3.4 After soldering, do not warp the circuit board.

### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than 350°C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

### 5. Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.

